



80V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	Rds(on)	Package	I _D T _C = +25°C
80V	$7.5 \text{m}\Omega @V_{GS} = 10 \text{V}$	TO220AB	111A

Description

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high-efficiency power management applications.

Applications

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

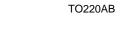
Features

- Low Input Capacitance
- High BV_{DSS} Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

 https://www.diodes.com/quality/product-definitions/

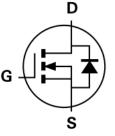
Mechanical Data

- Case: TO220AB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Terminal Connections: See Diagram Below
- Weight: TO220AB 1.85 grams (Approximate)

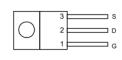








Equivalent Circuit



Top View Pin Out Configuration

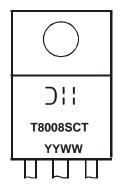
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT8008SCT	TO220AB	50 Pieces/Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



T8008SCT = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 21 = 2021)
WW or WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	80	V	
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current (Note 6) V _{GS} = 10V	$T_C = +25$ °C $T_C = +70$ °C	I _D	111 89	А
Maximum Continuous Body Diode Forward Current (Note 6)	ls	111	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	444	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 19	Ism	444	Α	
Avalanche Current, L=0.1mH (Note 8)	las	40	Α	
Avalanche Energy, L=0.1mH (Note 8)	Eas	80	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	P _D	2.4	W
Thermal Resistance, Junction to Ambient (Note 5)		RθJA	52	°C/W
Total Power Dissipation	Tc = +25°C	PD	167	W
Thermal Resistance, Junction to Case (Note 7)		R ₀ JC	0.75	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	80	_		V	V _G S = 0V, I _D = 1mA	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 60V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 1mA$	
Static Drain-Source On-Resistance	RDS(ON)	_	5.8	7.5	mΩ	Vgs = 10V, ID = 30A	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 30A	
DYNAMIC CHARACTERISTICS (Note 10)	•	•	•	•	•	•	
Input Capacitance	Ciss	_	1950	_		V _{DS} = 40V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	826	_	pF		
Reverse Transfer Capacitance	Crss	_	56	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 6V)	Qg	_	23	_		V _{DS} = 40V, I _D = 14A	
Total Gate Charge (VGS = 10V)	Qg	_	34	_	nC		
Gate-Source Charge	Qgs	_	6	_	nc nc		
Gate-Drain Charge	Q_{gd}	_	12	_			
Turn-On Delay Time	t _{D(ON)}	_	8	_		$V_{DD} = 40V, V_{GS} = 10V,$ $I_{D} = 14A, R_{G} = 6\Omega$	
Turn-On Rise Time	tR	_	15	_			
Turn-Off Delay Time	tD(OFF)	_	29	_	ns		
Turn-Off Fall Time	tr	_	21	_			
Body Diode Reverse Recovery Time	trr	_	43		ns	1 444 11/11 4004/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	49	_	$\frac{1}{100}$ Is = 14A, di/dt = 100A/µs		

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing.





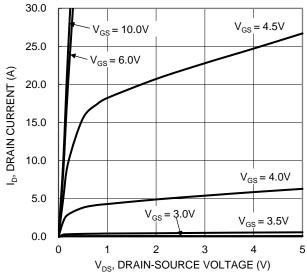


Figure 1. Typical Output Characteristic

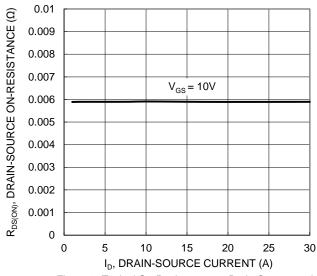


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

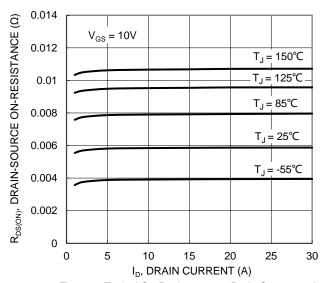


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

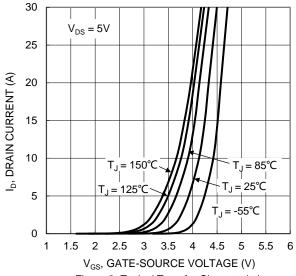


Figure 2. Typical Transfer Characteristic

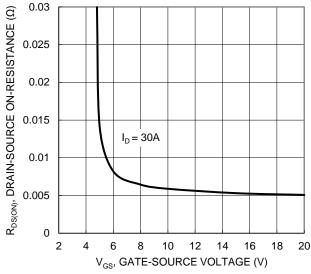


Figure 4. Typical Transfer Characteristic

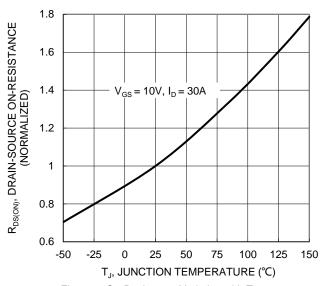


Figure 6. On-Resistance Variation with Temperature



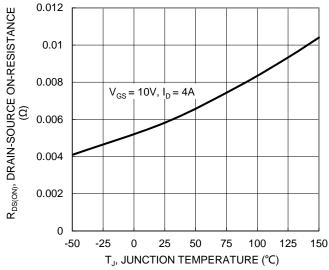


Figure 7. On-Resistance Variation with Temperature

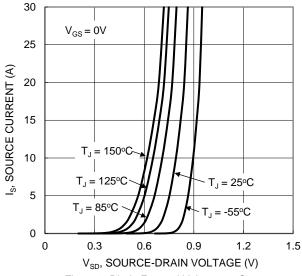


Figure 9. Diode Forward Voltage vs. Current

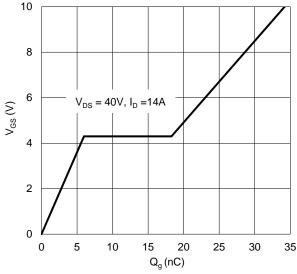


Figure 11. Gate Charge

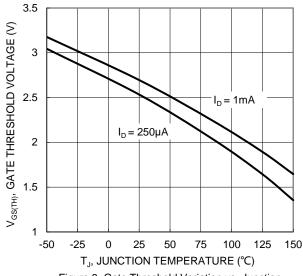


Figure 8. Gate Threshold Variation vs. Junction Temperature

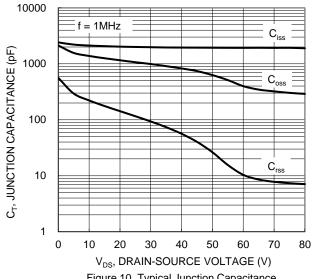


Figure 10. Typical Junction Capacitance

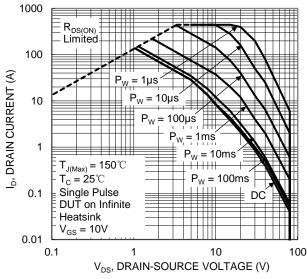


Figure 12. SOA, Safe Operation Area



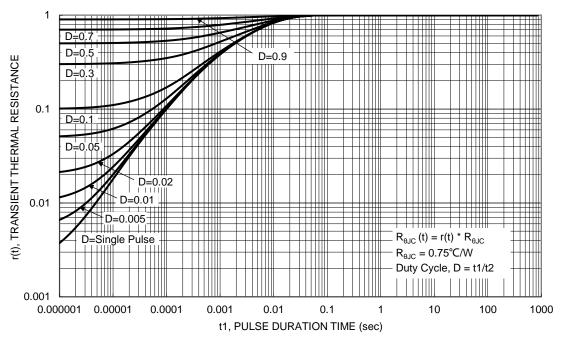


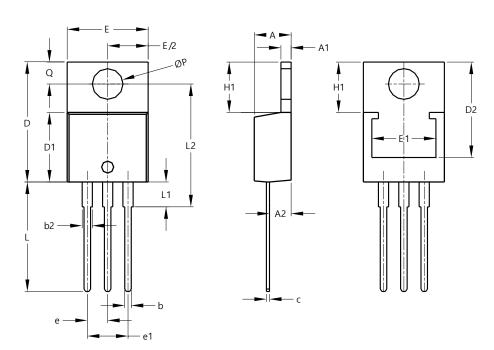
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO220AB



TO220AB					
Dim	Min	Max	Тур		
Α	3.56	4.82	-		
A1	0.51	1.39	-		
A2	2.04	2.92	-		
b	0.39	1.01	0.81		
b2	1.15	1.77	1.24		
C	0.356	0.61	-		
۵	14.22	16.51	-		
D1	8.39	9.01	-		
D2	11.45	12.87	-		
е	-	-	2.54		
e1	-	-	5.08		
Е	9.66	10.66	-		
E1	6.86	8.89	-		
H1	5.85	6.85	-		
ш	12.70	14.73	-		
L1	-	4.42	-		
L2	15.80	17.51	16.00		
Р	3.54	4.08	-		
ø	2.54	3.42	-		
All Dimensions in mm					



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